



Thermon Product Lifecycle Announcement:

EOL and EOS for HTC T-85 Old Formula and Availability of HTC T-85 New Formula

Thermon announces the end-of-life (EOL) and end-of-sale (EOS) for the old formula of T-85 heat transfer compound (HTC) and the availability of a new and improved formula. The new formula of T-85 is available for order from Thermon, effective immediately. Milestone dates are indicated below in Table 1. Refer to Table 2 for a cross-reference between obsolete and replacement item numbers.

Table 1: Milestone Definitions and Dates

Milestone	Definition	Date
New Product Press Release	The date that a new product's availability is publicly announced.	March 18, 2020
End-of-Life (EOL) Announcement	The date that the obsolete product's end-of-life is publicly announced.	June 18, 2020
End-of-Sale (EOS):	The last date to order the obsolete product from Thermon. The product is no longer available for sale from Thermon after this date.	July 31, 2020
Last Shipment:	The latest shipment date that can be requested from Thermon for the obsolete product. The actual shipment date is dependent upon specific product lead time.	September 30, 2020

Table 2: Item Number Cross-Reference

Customer Order Number	Obsolete Thermon Item Number	Replacement Thermon Item Number	Replacement Product Description
HTC T-85-1	16034	16040	Heat Transfer Compound (Epoxy) for temperatures up to 450°F (232°C), 4 L (1.06 gal). 1 Year Shelf Life.
HTC T-85-C	16037	16041	Heat Transfer Compound (Epoxy) for temperatures up to 450°F (232°C), 300 ml (10.1 oz). 1 Year Shelf Life.
HTC T-85-5	16035	16042	Heat Transfer Compound (Epoxy) for temperatures up to 450°F (232°C), 20 L (5.28 gal). 1 Year Shelf Life.

Product Transition Information

The new and improved T-85 formula is a direct replacement for the old formula. Improvements include:

- Industry-leading shelf life of 1 year, compared with old formula shelf lives of 30-90 days
- Increased Maximum Exposure Temperature of 232 °C (450 °F) compared to 190 °C (375 °F)
- Improved Minimum Product Temperature at Installation of 50 °F (10 °C) compared to 70 °F (20 °C)
- Increased Bond Strength of > 20,700 kPa (> 3000 psi) compared to 12,411 kPa (1800 psi)

T-85 Press Release: <https://www.thermon.com/us/thermon-introduces-new-formulations-for-our-heat-transfer-compounds>

T-85 Webpage: <https://www.thermon.com/us/products/steam-heating/heat-transfer-compounds/t-85>

T-85 Specification Sheet: https://content.thermon.com/pdf/us_pdf_files/TSP0016-T-85-Spec.pdf

Thermon General T&Cs: <https://www.thermon.com/us/terms--conditions>